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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.	
09/836,081	04/17/2001	Norio Sakai	36856.466	8268	
75	590 11/03/2004		EXAMINER		
Keating & Bennett LLP			CHAMBLISS, ALONZO		
Suite 312 10400 Eaton Pla	ace		ART UNIT	PAPER NUMBER	
Fairfax, VA 2	2030		2814		
			DATE MAILED: 11/03/2004	DATE MAILED: 11/03/2004	

Please find below and/or attached an Office communication concerning this application or proceeding.

.		Application No.	Applicant(s)	<u>.</u>
		09/836,081	SAKAI, NORIO	
•	Office Action Summary	Examiner	Art Unit	
		Alonzo Chambliss	2814	pr
	The MAILING DATE of this communication app	pears on the cover sheet with the	correspondence add	ress
THE - Exte after - If the - If NC - Failu Any	ORTENED STATUTORY PERIOD FOR REPL' MAILING DATE OF THIS COMMUNICATION. nsions of time may be available under the provisions of 37 CFR 1.1. SIX (6) MONTHS from the mailing date of this communication. e period for reply specified above is less than thirty (30) days, a reply period for reply is specified above, the maximum statutory period of the provision of the provisions of 37 CFR 1.1. Description of the provision of the provisions of 37 CFR 1.1. Description of the provision of 37 CFR	36(a). In no event, however, may a reply be t y within the statutory minimum of thirty (30) da vill apply and will expire SIX (6) MONTHS fror , cause the application to become ABANDON	imely filed ays will be considered timely. the mailing date of this con ED (35 U.S.C. § 133).	nmunication.
Status			,	
·	•—	action is non-final.		merits is
Disposit	ion of Claims			
5)□ 6)⊠ 7)□	Claim(s) 1-4,6,13-16 and 18 is/are pending in (4a) Of the above claim(s) is/are withdraw Claim(s) is/are allowed. Claim(s) 1-4,6,13-16 and 18 is/are rejected. Claim(s) is/are objected to. Claim(s) are subject to restriction and/o	wn from consideration.		
Applicati	ion Papers			
10)	The specification is objected to by the Examine The drawing(s) filed on is/are: a) accomplicant may not request that any objection to the Replacement drawing sheet(s) including the correct The oath or declaration is objected to by the Examine	epted or b) objected to by the drawing(s) be held in abeyance. So ion is required if the drawing(s) is o	ee 37 CFR 1.85(a). bjected to. See 37 CFF	, ,
Priority (under 35 U.S.C. § 119			
12)□ a)l	Acknowledgment is made of a claim for foreign All b) Some * c) None of: 1. Certified copies of the priority documents 2. Certified copies of the priority documents 3. Copies of the certified copies of the priority documents application from the International Bureau See the attached detailed Office action for a list	s have been received. s have been received in Applica rity documents have been receiv u (PCT Rule 17.2(a)).	tion No ved in this National S	stage
Attachmen	t(s)			
2) 🔲 Notic 3) 🔯 Infor	te of References Cited (PTO-892) te of Draftsperson's Patent Drawing Review (PTO-948) mation Disclosure Statement(s) (PTO-1449 or PTO/SB/08) or No(s)/Mail Date 6/8/04.	4) Interview Summar Paper No(s)/Mail E 5) Notice of Informal 6) Other:	Date	152)

DETAILED ACTION

Continued Examination Under 37 CFR 1.114

1. A request for continued examination under 37 CFR 1.114, including the fee set forth in 37 CFR 1.17(e), was filed in this application after allowance or after an Office action under *Ex Parte Quayle*, 25 USPQ 74, 453 O.G. 213 (Comm'r Pat. 1935). Since this application is eligible for continued examination under 37 CFR 1.114, and the fee set forth in 37 CFR 1.17(e) has been timely paid, prosecution in this application has been reopened pursuant to 37 CFR 1.114. Applicant's submission filed on 6/8/04 has been entered.

Response to Arguments

2. Applicant's arguments with respect to claims 1-4, 6, 13 -16, and 18 have been considered but are most in view of the new ground(s) of rejection.

Information Disclosure Statement

3. The information disclosure statement (IDS) submitted on 6/8/04 was filed before the mailing date of the non-final rejection on 10/25/04. The submission is in compliance with the provisions of 37 CFR 1.97. Accordingly, the information disclosure statement is being considered by the examiner.

Drawings

4. The formal drawings filed on 1/12/04 have been approved by the examiner.

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Claim Rejections - 35 USC § 103

5. The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

- (a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.
- 6. Claims 1-4, 6, 13-16, and 18 are rejected under 35 U.S.C. 103(a) as being unpatentable over Takubo et al. (6,329,610) in view of Tadaharu et al. (JP 6-268369).

With respect to Claims 1 and 13, Takubo discloses a laminated ceramic electronic component 10 (device of figures 1-3) comprising: a laminated member including a plurality of stacked ceramic layers (reference numbers 21 and 23) having a first ceramic layer (reference number 21) and a second ceramic layer (reference number 23) which is thinner than the first ceramic layer; wiring conductors provided for a certain layer of the ceramic layers and including a viahole conductor (reference number 32 and 31) extending through the certain layer and a conductor (reference number 11a) extending a6ong the principal surface of said certain layer, wherein the via-hole conductor includes first (reference number 31) and second (reference number 32) via- hole conductors having different sectional sizes. A wiring board (i.e. mother board) for mounting the laminated ceramic electronic component 10 thereon. Takubo fails to explicitly disclose the aspect ratio expressed by H/D is within the range of approximately

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.1 to approximately 3, wherein H and D represent the height and radial length for each of the via hole conductors. However, Tadaharu discloses the aspect ratio expressed by H/D is within the range of approximately .1 to approximately 3 (i.e. .25), wherein H and D represent the height and radial length for the via hole conductors 3 (see English translation, paragraph 15). Thus, Takubo and Tadaharu have substantially the same environment of board with a via hole filled with conductive material. Therefore, one skilled in the art at the time of the invention would readily recognize having incorporate the aspect ratio of .25 for each via hole conductor of Takubo, since the aspect ratio would eliminate continuity defects due to the shortage of filling in a via hole and defects at the time of forming a wiring pattern due to the extrusion of a via land as taught by Tadaharu.

With respect to Claims 2, 3, 14, and 15, Takubo discloses wherein a first via hole conductor 31 extends through the first ceramic layer, a second via hole conductor 32 extends through the second ceramic layer, and the sectional size of the first via hole conductor is larger than that of the second via hole conductor since the land 11a, 12a attached to the first via hole conductor 31 is larger than the land 14a attached to the second via hole conductor 32. Therefore, all of the via hole conductors, the sectional size of the via hole conductor extending through the thicker ceramic layer is larger than that of the via hole conductor extending through the thinner ceramic layer (see col. 21 lines 22-25 and col. 22 lines 23-26; Figs. 1 and 3).

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With respect to Claims 4 and 16, Tadaharu discloses wherein a plurality of the via hole conductors extending through the same ceramic layer have substantially the same sectional size (see English translation).

With respect to Claims 6 and 18, Takubo discloses wherein the plurality of ceramic layers 21, 23 inherently have substantially the same dielectric constant based on the composition of ceramic layers 21, 23 when both have a coefficient of thermal expansion of 13 to 15 ppm/°C (see col. 17 lines 25-52).

The prior art made of record and not relied upon is cited primarily to show the product of the instant invention.

Conclusion

7. Any inquiry concerning the communication or earlier communications from the examiner should be directed to Alonzo Chambliss whose telephone number is (571) 272-1927.

Any inquiry of a general nature or relating to the status of this application or proceeding should be directed to the Group receptionist whose telephone number is (703) 308-7956

Information regarding the status of an application may be obtained from the Patent Application Information Retrieval (PAIR) system Status information for published applications may be obtained from either Private PMR or Public PMR. Status information for unpublished applications is available through Private PMR only. For more information about the PMR system see http://pair-dkect.uspto.gov. Should you have questions on access to the Private PMR

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system contact the Electronic Business Center (EBC) at 866-217-9197 (toll-free)

or EBC_Support@uspto.gov.

Alonzo Chambliss

Primary Patent Examiner

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